Combined Voltage & Current Output with Protection

PCB Number: TIDA-00559
PCB Rev: E1

Texas Instruments

Pb-Free Symbol

Pb-free (RoHS)

FCC disclaimer

H1
SJ5382
H2
SJ5382
H3
SJ5382
H4
SJ5382

Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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